

# RS90LV048 3-V LVDS Quad CMOS Differential Line Receiver

## 1 FEATURES

- **Conforms to TIA/EIA-644 Standard**
- **>400Mbps (200MHz) Switching Rates**
- **100ps Differential Skew**
- **3.3V Power Supply**
- **±350mV Differential Signaling**
- **Supports Input Failsafe Open, Short, and Terminated**
- **Low Power Dissipation (52.8mW at  $V_{CC}=3.3V$  Typical)**
- **TSSOP16 Package**
- **Industrial Temperature Operating Range (-40°C ~85°C)**

## 2 APPLICATIONS

- **Multifunction Printers**
- **LVDS-LVCMOS Translation**

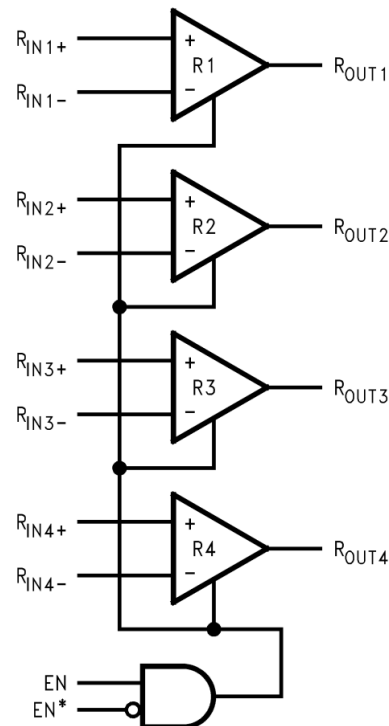
## 3 ADVANTAGES

- >200MHz Switching Rates.
- Accept small input swing ( $\pm 350mV$  typically).
- 52.8mW low power dissipation.
- support open, shorted, and terminated ( $100\Omega$ ) input fail-safe.
- TSSOP16 Package.

**Device Information (1)**

PART NUMBER	PACKAGE	BODY SIZE(NOM)
RS90LV048	TSSOP16	5.00mm×4.40mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.



**Figure 1. Functional Diagram**

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## 4 REVISION HISTORY

Note: Page numbers for previous revisions may differ from page numbers in the current version.

VERSION	Change Date	Change Item
A.0	2024/11/12	Initial version
A.1	2024/12/05	Add machine test results

**5 PACKAGE/ORDERING INFORMATION <sup>(1)</sup>**

PRODUCT	ORDERING NUMBER	PACKAGE LEAD	TEMPERATURE RANGE	PACKAGE MARKING <sup>(2)</sup>	MSL <sup>(3)</sup>	PACKAGE OPTION
RS90LV048	RS90LV048YTSS16	TSSOP16	-40°C ~85°C	RS90LV048	MSL1	Tape and Reel,4000

## NOTE:

- (1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.
- (2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.
- (3) RUNIC classify the MSL level with using the common preconditioning setting in our assembly factory conforming to the JEDEC industrial standard J-STD-20F, Please align with RUNIC if your end application is quite critical to the preconditioning setting or if you have special requirement.

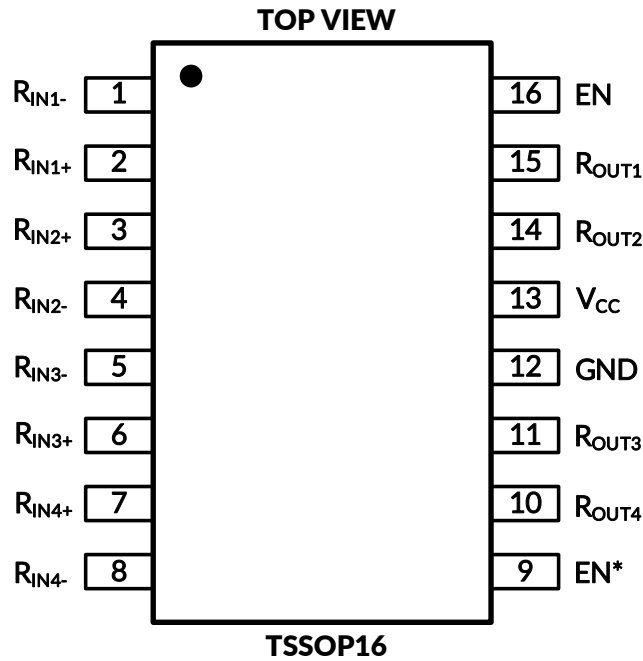
## **6 DESCRIPTION**

The RS90LV048 device is a quad CMOS flow through differential line receiver designed for applications requiring ultra-low power dissipation and high data rates. The device is designed to support data rates in excess of 400 Mbps (200 MHz) using Low Voltage Differential Signaling (LVDS) technology.

The RS90LV048 accepts low voltage (350 mV typical) differential input signals and translates them to 3-V CMOS output levels. The receiver supports a TRI-STATE function that may be used to multiplex outputs. The receiver also supports open, shorted, and terminated (100- $\Omega$ ) input fail-safe. The receiver output is HIGH for all fail-safe conditions.

The EN and EN\* inputs are ANDed together and control the TRI-STATE outputs. The enables are common to all four receivers. The RS90LV048 and companion LVDS line driver (for example, RS90LV047) provide a new alternative to high power PECL/ECL devices for high-speed point-to point interface applications.

## 7 PIN CONFIGURATIONS



## PIN DESCRIPTIONS

Name	PIN	DESCRIPTION
EN	16	Receiver enable pin: When EN is low, the receiver is disabled. When EN is high and EN* is low or open, the receiver is enabled. If both EN and EN* are open circuit, then the receiver is disabled.
EN*	9	Receiver enable pin: When EN* is high, the receiver is disabled. When EN* is low or open and EN is high, the receiver is enabled. If both EN and EN* are open circuit, then the receiver is disabled.
GND	12	Ground pin
R <sub>IN+</sub>	2,3,6,7	Noninverting receiver input pin
R <sub>IN-</sub>	1,4,5,8	inverting receiver input pin
R <sub>OUT</sub>	10, 11, 14,15	Receiver output pin
V <sub>CC</sub>	13	Power supply pin, 3.3 V ± 0.3 V

## 8 SPECIFICATIONS

### 8.1 Absolute Maximum Ratings

PARAMETER	MIN	MAX	UNIT
Supply Voltage ( $V_{CC}$ )	-0.3	4	V
Input voltage ( $R_{IN+}$ , $R_{IN-}$ )	-0.3	3.6	V
Enable input voltage ( $EN$ , $EN^*$ )	-0.3	$V_{CC}+0.3$	V
Output voltage ( $R_{OUT}$ )	-0.3	$V_{CC}+0.3$	V
Maximum Junction Temperature		150	°C
Storage temperature	-65	150	°C

Note: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be specified. They are not meant to imply that the devices should be operated at these limits.

### 8.2 Recommended Operating Conditions

	MIN	TYP	MAX	UNIT
Supply Voltage ( $V_{CC}$ )	3	3.3	3.6	V
Temperature ( $T_A$ )	-40	25	85	°C

### 8.3 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

		VALUE	UNIT
$V_{(ESD)}$	Human-Body Model (HBM)	$\geq 8000$	V
	Charged-Device Model (CDM)	$\geq 2000$	V
	Latch-Up (LU)	$\geq 400$	mA



Electric devices and circuit boards may discharge undetected. Although this product has a patented or proprietary protection circuit, the device may be damaged when exposed to high energy ESD. Therefore, appropriate ESD prevention measures should be taken to avoid device performance degradation or loss of function.

## 8.4 Electrical Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified.  $V_{CC}=+3.3V\pm 10\%$ ,  $T_A=-40^{\circ}C$  to  $85^{\circ}C$ .

SYMBOL	PARAMETER	CONDITION		MIN	TYP	MAX	UNIT	
$V_{TH}$	Differential input high threshold	$V_{CM}=+1.2V, 0.05V, 2.95V$	$R_{IN+}, R_{IN-}$		-35	0	mV	
$V_{TL}$	Differential input low threshold			-100	-35		mV	
$V_{CMR}$	Common-mode voltage	$V_{ID}=200mV$		0.1		2.3	V	
$I_{IN}$	Input current	$V_{IN}=+2.8V, V_{CC}=3.6V$ or $0V$		-10	$\pm 4.3$	10	$\mu A$	
		$V_{IN}=0V, V_{CC}=3.6V$ or $0V$		-10	$\pm 3$	10		
		$V_{IN}=+3.6V, V_{CC}=0V$		-10	$\pm 1$	20		
$V_{OH}$	Output high voltage	$I_{OH}=-0.4mA, V_{ID}=200mV$		$R_{OUT}$	2.7	3.3		V
		$I_{OH}=-0.4mA$ , input terminated			2.7	3.3		V
		$I_{OH}=-0.4mA$ , input shorted			2.7	3.3		V
$V_{OL}$	Output low voltage	$I_{OH}=2mA, V_{ID}=-200mV$				0.05	0.25	V
$I_{OS}$	Output short-circuit current	Enabled, $V_{OUT}=0V$	-15		-44.3	-100	mA	
$I_{OZ}$	Output TRI-STATE current	Disabled, $V_{OUT}=0$ or $V_{CC}$	-10		$\pm 1$	10	$\mu A$	
$V_{IH}$	Input high voltage		$EN, EN^*$		2		$V_{CC}$	V
$V_{IL}$	Input low voltage			GND		0.8	V	
$I_I$	Input current	$V_{IN}=0V$ or $V_{CC}$ , other Input = $V_{CC}$ or GND		-10	$\pm 4.7$	10	$\mu A$	
$I_{CC}$	No load supply current receivers enabled	$EN=V_{CC}$ , input open	$V_{CC}$		16	20.3	mA	
$I_{CCZ}$	No load supply current receivers disabled	$EN=GND$ , input open			0.68	5	mA	

Note:

1. Current into device pins is defined as positive. Current out of device pins is defined as negative.
2. All typical are given for:  $V_{CC}=3.3V$  and  $T_A=25^{\circ}C$ .



## 8.5 Switching Characteristics

SYMBOL	PARAMETER	CONDITION	MIN	TYP	MAX	UNIT
t <sub>PHLD</sub>	Differential propagation delay high to low	C <sub>L</sub> =15pF V <sub>ID</sub> =200mV	1.5	1.7	2.7	ns
t <sub>PLHD</sub>	Differential propagation delay low to high		1.3	1.6	2.7	ns
t <sub>SKD1</sub>	t <sub>PHLD</sub> - t <sub>PLHD</sub>		0.1	0.4	ns	
t <sub>TLH</sub>	Rise time		0.3	0.5	0.8	ns
t <sub>THL</sub>	Fall time		0.2	0.3	0.8	ns
t <sub>PHZ</sub>	Disable time high to Z	R <sub>L</sub> =2kΩ C <sub>L</sub> =15pF		10	14	ns
t <sub>PLZ</sub>	Disable time low to Z			10	14	ns
t <sub>PZH</sub>	Enable time Z to high			7	14	ns
t <sub>PZL</sub>	Enable time Z to low			7	14	ns
f <sub>MAX</sub>	Maximum operating frequency	All channels switching	200	250		MHz

Note:

1. Generator waveform for all tests unless otherwise specified: f = 1 MHz, Z<sub>o</sub> = 50 Ω, t<sub>r</sub> and t<sub>f</sub> (0% to 100%) ≤ 3 ns for R<sub>IN</sub>.
2. f<sub>MAX</sub> generator input conditions: t<sub>r</sub> = t<sub>f</sub> < 1 ns (0%-100%), 50% duty cycle, differential (1.05-V to 1.35-V peak to peak). Output criteria: 60 / 40% duty cycle, V<sub>OL</sub> (maximum 0.25 V), V<sub>OH</sub> (minimum 2.7 V), Load = 15 pF (stray plus probes).

## 9 TEST CIRCUITS AND TRANSITION TIME WAVEFORMS

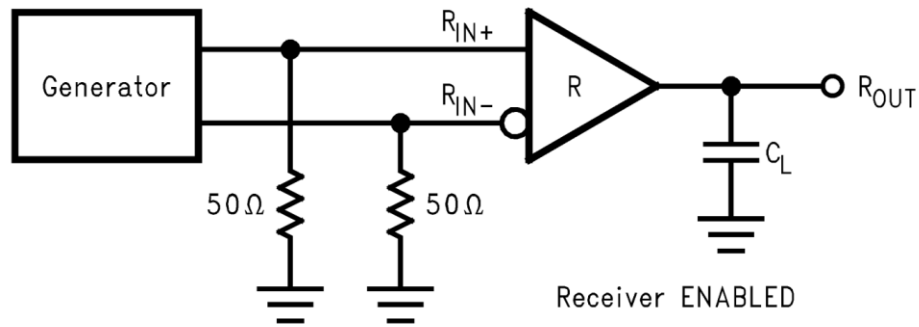


Figure 2. Differential Driver DC Test Circuit

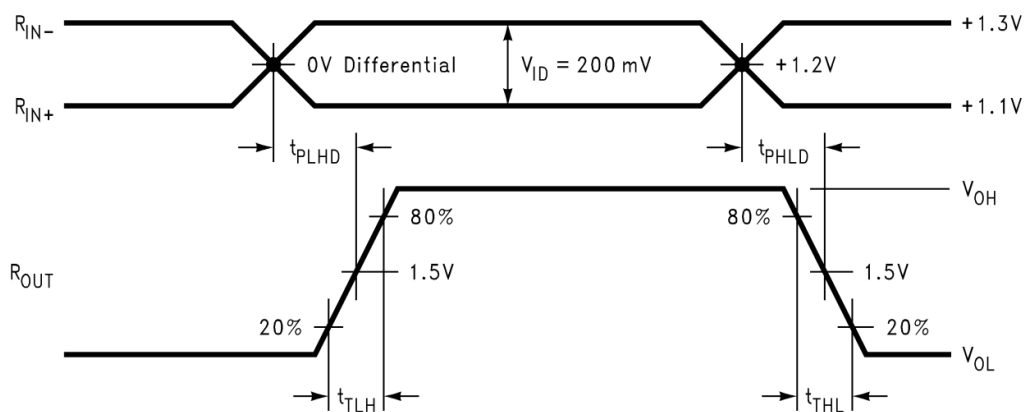
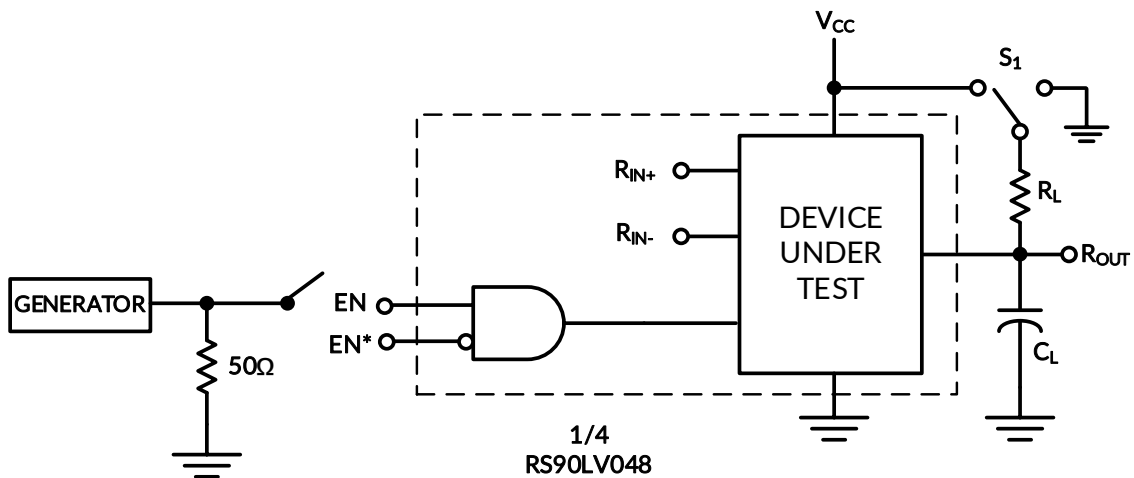
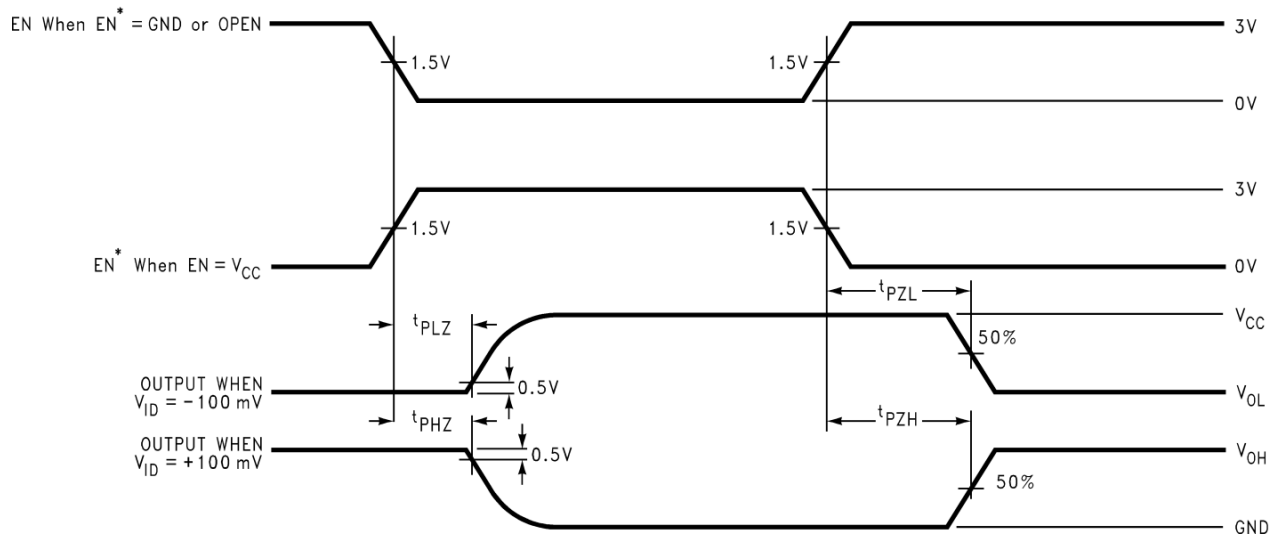


Figure 3. Differential Driver Propagation Delay and Transition Time Test Circuit



$C_L$  includes load and test jig capacitance.  
 $S_1 = V_{CC}$  for  $t_{pZL}$  and  $t_{pL}$  measurement.  
 $S_1 = GND$  for  $t_{pZH}$  and  $t_{pHZ}$  measurement.

Figure 4. Differential Driver Propagation Delay and Transition Time Waveforms



**Figure 5. Driver TRI-STATE Delay Test Circuit**

## 10 DEVICE FUNCTIONAL MODES

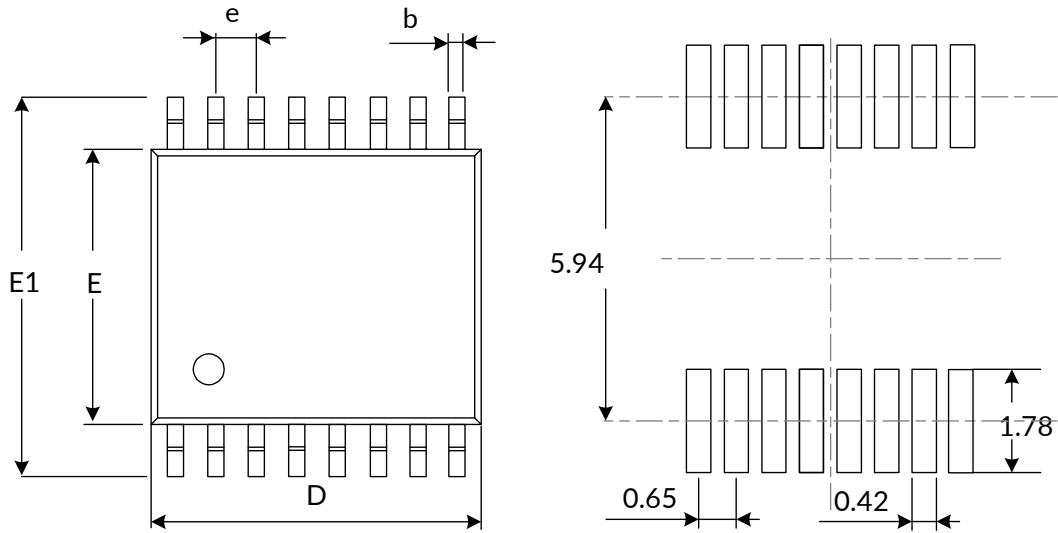
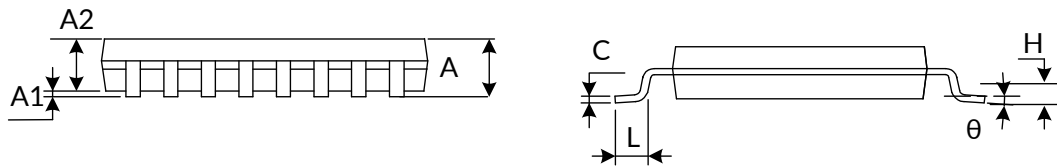
Table 1 lists the functional modes RS90LV048.

**Table 1. functional modes**

		INPUT	OUTPUT
EN	EN*	RIN+ - RIN-	Rout
H	L or Open	$V_{ID} \geq 0\text{ V}$	H
		$V_{ID} \leq -0.1\text{ V}$	L
		Full Fail-safe open/short or terminated	H
All other combinations of ENABLE inputs		X	Z

# 11 PACKAGE OUTLINE DIMENSIONS

## TSSOP16<sup>(3)</sup>


**RECOMMENDED LAND PATTERN (Unit: mm)**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A <sup>(1)</sup>		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D <sup>(1)</sup>	4.860	5.100	0.191	0.201
E <sup>(1)</sup>	4.300	4.500	0.169	0.177
E1	6.200	6.600	0.244	0.260
e	0.650(BSC) <sup>(2)</sup>		0.026(BSC) <sup>(2)</sup>	
L	0.500	0.700	0.02	0.028
H	0.250 TYP		0.010 TYP	
θ	1°	7°	1°	7°

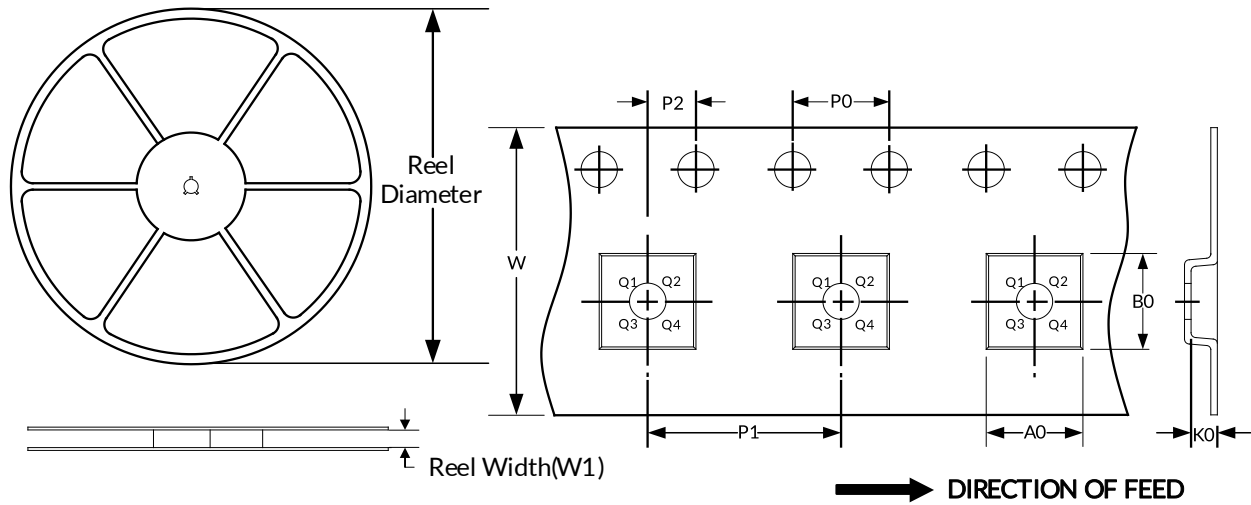
**NOTE:**

1. Plastic or metal protrusions of 0.15mm maximum per side are not included.
2. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
3. This drawing is subject to change without notice.

## 12 TAPE AND REEL INFORMATION

### REEL DIMENSIONS

### TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

### KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width(mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
TSSOP16	13"	12.4	6.90	5.60	1.20	4.0	8.0	2.0	12.0	Q1

NOTE:

1. All dimensions are nominal.
2. Plastic or metal protrusions of 0.15mm maximum per side are not included.

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